

Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <http://www.nxp.com>, <http://www.philips.com/> or <http://www.semiconductors.philips.com/>, use <http://www.nexperia.com>

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use salesaddresses@nexperia.com (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © **Nexperia B.V. (year). All rights reserved.**

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via salesaddresses@nexperia.com). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

74AHC574; 74AHCT574

Octal D-type flip-flop; positive edge-trigger; 3-state

Rev. 02 — 24 January 2008

Product data sheet

1. General description

The 74AHC574; 74AHCT574 are high-speed Si-gate CMOS devices and are pin compatible with Low Power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard no. 7A.

The 74AHC574; 74AHCT574 are octal D-type flip-flops featuring separate D-type inputs for each flip-flop and 3-state outputs for bus oriented applications. A clock (CP) and an output enable (\overline{OE}) input are common to all flip-flops.

The 8 flip-flops will store the state of their individual D-inputs that meet the set-up and hold times requirements on the LOW-to-HIGH CP transition.

When \overline{OE} is LOW the contents of the 8 flip-flops are available at the outputs. When \overline{OE} is HIGH, the outputs go to the high-impedance OFF-state. Operation of the \overline{OE} input does not affect the state of the flip-flops.

The 74AHC574; 74AHCT574 is functionally identical to the 74AHC564; 74AHCT564, but has non-inverting outputs. The 74AHC574; 74AHCT574 is functionally identical to the 74AHC374; 74AHCT374, but has a different pinning.

2. Features

- Balanced propagation delays
- All inputs have a Schmitt-trigger action
- 3-state non-inverting outputs for bus orientated applications
- 8-bit positive, edge-triggered register
- Independent register and 3-state buffer operation
- Common 3-state output enable input
- For 74AHC574 only: operates with CMOS input levels
- For 74AHCT574 only: operates with TTL input levels
- ESD protection:
 - ◆ HBM JESD22-A114E exceeds 2000 V
 - ◆ MM JESD22-A115-A exceeds 200 V
 - ◆ CDM JESD22-C101C exceeds 1000 V
- Multiple package options
- Specified from $-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$ and from $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$

3. Ordering information

Table 1. Ordering information

| Type number | Package | | | Version |
|---------------------------|-------------------|----------|--|----------|
| | Temperature range | Name | Description | |
| 74AHC574D 74AHCT574D | -40 °C to +125 °C | SO20 | plastic small outline package; 20 leads; body width 7.5 mm | SOT163-1 |
| 74AHC574PW 74AHCT574PW | -40 °C to +125 °C | TSSOP20 | plastic thin shrink small outline package; 20 leads; body width 4.4 mm | SOT360-1 |
| 74AHC574BQ 74AHCT574BQ | -40 °C to +125 °C | DHVQFN20 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm | SOT764-1 |

4. Functional diagram

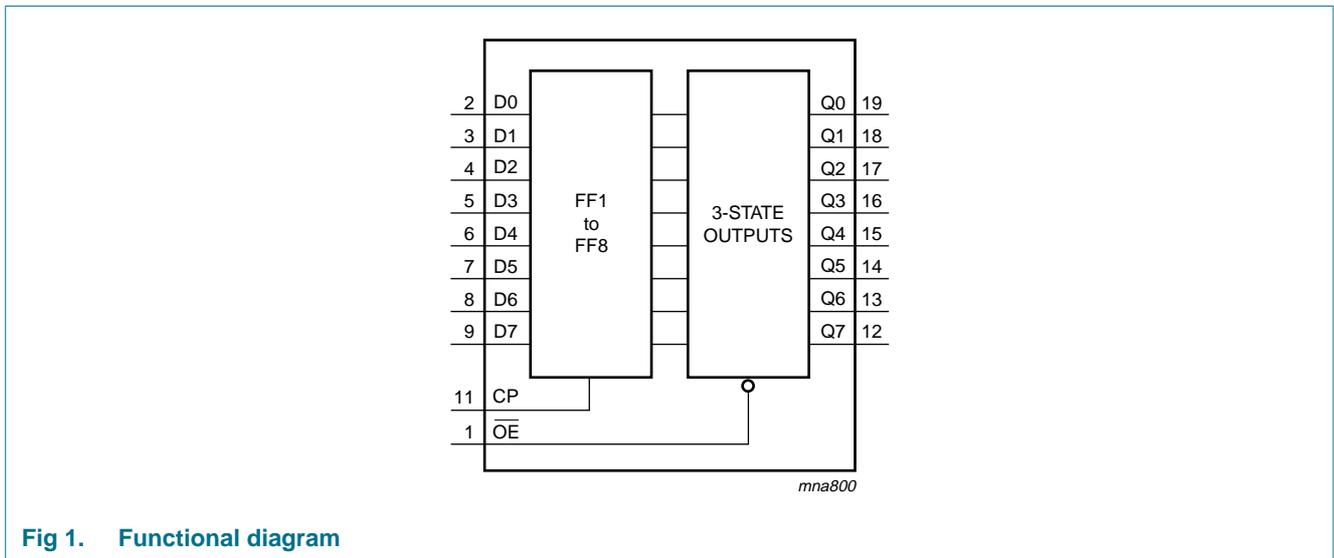


Fig 1. Functional diagram

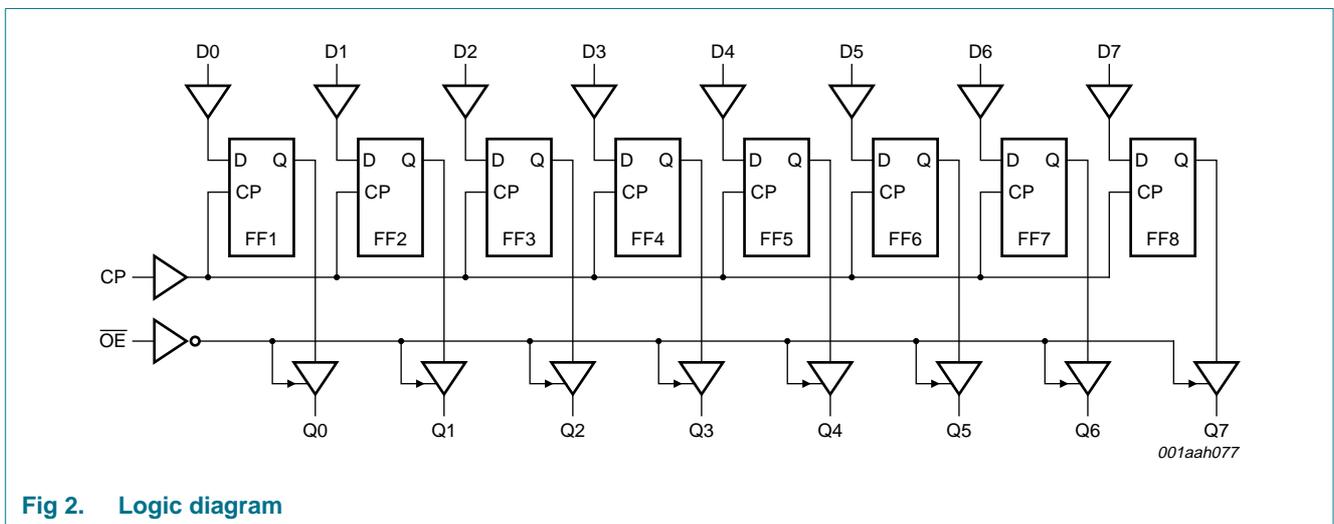


Fig 2. Logic diagram

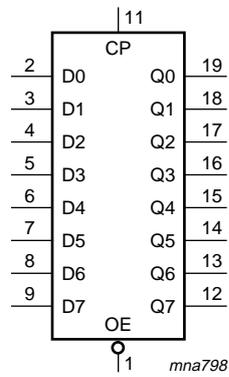


Fig 3. Logic symbol

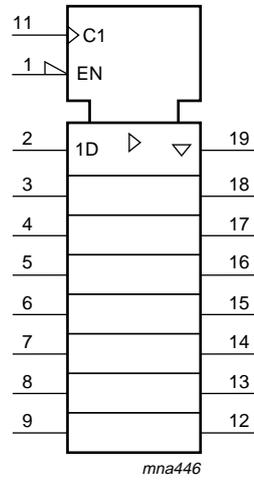
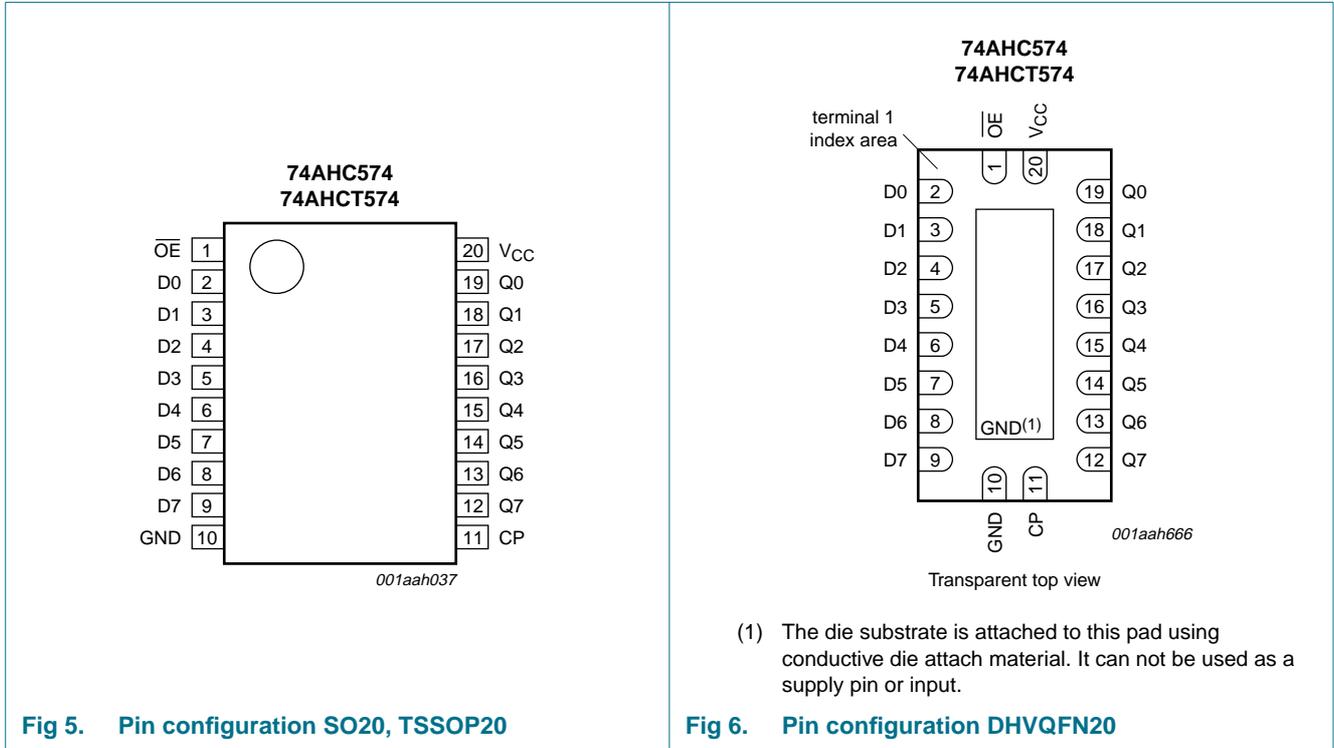


Fig 4. IEC logic symbol

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------|--------------------------------|---|
| \overline{OE} | 1 | 3-state output enable input (active LOW) |
| D[0:7] | 2, 3, 4, 5, 6, 7, 8, 9 | data input |
| GND | 10 | ground (0 V) |
| CP | 11 | clock input (LOW-to-HIGH, edge triggered) |
| Q[0:7] | 19, 18, 17, 16, 15, 14, 13, 12 | 3-state flip-flop output |
| V _{CC} | 20 | supply voltage |

6. Functional description

Table 3. Function table^[1]

| Operating mode | Input | | | Internal flip-flop | Output Qn |
|----------------------------------|-----------------|----|----|--------------------|-----------|
| | \overline{OE} | CP | Dn | | |
| Load and read register | L | ↑ | l | L | L |
| | L | ↑ | h | H | H |
| Load register and disable output | H | ↑ | l | L | Z |
| | H | ↑ | h | H | Z |

- [1] H = HIGH voltage level;
 h = HIGH voltage level one setup time prior to the HIGH-to-LOW CP transition;
 L = LOW voltage level;
 l = LOW voltage level one setup time prior to the HIGH-to-LOW CP transition;
 Z = high-impedance OFF-state;
 ↑ = LOW-to-HIGH clock transition.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-------------------------|--|---------|------|------|
| V_{CC} | supply voltage | | -0.5 | +7.0 | V |
| V_I | input voltage | | -0.5 | +7.0 | V |
| I_{IK} | input clamping current | $V_I < -0.5\text{ V}$ | [1] -20 | - | mA |
| I_{OK} | output clamping current | $V_O < -0.5\text{ V}$ or $V_O > V_{CC} + 0.5\text{ V}$ | [1] - | ±20 | mA |
| I_O | output current | $V_O = -0.5\text{ V}$ to $(V_{CC} + 0.5\text{ V})$ | - | ±25 | mA |
| I_{CC} | supply current | | - | 75 | mA |
| I_{GND} | ground current | | -75 | - | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | total power dissipation | $T_{amb} = -40\text{ °C}$ to $+125\text{ °C}$ | | | |
| | SO20 package | | [2] - | 500 | mW |
| | TSSOP20 package | | [3] - | 500 | mW |
| | DHVQFN20 package | | [4] - | 500 | mW |

- [1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 [2] P_{tot} derates linearly with 8 mW/K above 70 °C.
 [3] P_{tot} derates linearly with 5.5 mW/K above 60 °C.
 [4] P_{tot} derates linearly with 4.5 mW/K above 60 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | 74AHC574 | | | 74AHCT574 | | | Unit |
|------------------|-------------------------------------|---------------------------------|----------|-----|-----------------|-----------|-----|-----------------|------|
| | | | Min | Typ | Max | Min | Typ | Max | |
| V _{CC} | supply voltage | | 2.0 | 5.0 | 5.5 | 4.5 | 5.0 | 5.5 | V |
| V _I | input voltage | | 0 | - | 5.5 | 0 | - | 5.5 | V |
| V _O | output voltage | | 0 | - | V _{CC} | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | +25 | +125 | -40 | +25 | +125 | °C |
| Δt/ΔV | input transition rise and fall rate | V _{CC} = 3.3 V ± 0.3 V | - | - | 100 | - | - | - | ns/V |
| | | V _{CC} = 5.0 V ± 0.5 V | - | - | 20 | - | - | 20 | ns/V |

9. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|--------------------------|---------------------------|--|-------|-----|-------|------------------|------|-------------------|-------|------|
| | | | Min | Typ | Max | Min | Max | Min | Max | |
| For type 74AHC574 | | | | | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 2.0 V | 1.5 | - | - | 1.5 | - | 1.5 | - | V |
| | | V _{CC} = 3.0 V | 2.1 | - | - | 2.1 | - | 2.1 | - | V |
| | | V _{CC} = 5.5 V | 3.85 | - | - | 3.85 | - | 3.85 | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 2.0 V | - | - | 0.5 | - | 0.5 | - | 0.5 | V |
| | | V _{CC} = 3.0 V | - | - | 0.9 | - | 0.9 | - | 0.9 | V |
| | | V _{CC} = 5.5 V | - | - | 1.65 | - | 1.65 | - | 1.65 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} | | | | | | | | |
| | | I _O = -50 μA; V _{CC} = 2.0 V | 1.9 | 2.0 | - | 1.9 | - | 1.9 | - | V |
| | | I _O = -50 μA; V _{CC} = 3.0 V | 2.9 | 3.0 | - | 2.9 | - | 2.9 | - | V |
| | | I _O = -50 μA; V _{CC} = 4.5 V | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | I _O = -4.0 mA; V _{CC} = 3.0 V | 2.58 | - | - | 2.48 | - | 2.40 | - | V |
| | | I _O = -8.0 mA; V _{CC} = 4.5 V | 3.94 | - | - | 3.8 | - | 3.70 | - | V |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} | | | | | | | | |
| | | I _O = 50 μA; V _{CC} = 2.0 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 50 μA; V _{CC} = 3.0 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 50 μA; V _{CC} = 4.5 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 4.0 mA; V _{CC} = 3.0 V | - | - | 0.36 | - | 0.44 | - | 0.55 | V |
| | | I _O = 8.0 mA; V _{CC} = 4.5 V | - | - | 0.36 | - | 0.44 | - | 0.55 | V |
| I _{OZ} | OFF-state output current | V _I = V _{IH} or V _{IL} ; V _O = V _{CC} or GND; V _{CC} = 5.5 V | - | - | ±0.25 | - | ±2.5 | - | ±10.0 | μA |
| I _I | input leakage current | V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V | - | - | 0.1 | - | 1.0 | - | 2.0 | μA |
| I _{CC} | supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 4.0 | - | 40 | - | 80 | μA |

Table 6. Static characteristics ...continued
 Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|---------------------------|---------------------------|---|-------|-----|-------|------------------|------|-------------------|-------|------|
| | | | Min | Typ | Max | Min | Max | Min | Max | |
| C _I | input capacitance | | - | 3.0 | 10 | - | 10 | - | 10 | pF |
| C _O | output capacitance | | - | 4.0 | - | - | - | - | - | pF |
| For type 74AHCT574 | | | | | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 4.5 V to 5.5 V | 2.0 | - | - | 2.0 | - | 2.0 | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 4.5 V to 5.5 V | - | - | 0.8 | - | 0.8 | - | 0.8 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V | | | | | | | | |
| | | I _O = -50 µA | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | I _O = -8.0 mA | 3.94 | - | - | 3.8 | - | 3.70 | - | V |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V | | | | | | | | |
| | | I _O = 50 µA | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 8.0 mA | - | - | 0.36 | - | 0.44 | - | 0.55 | V |
| I _{OZ} | OFF-state output current | per input pin; V _I = V _{IH} or V _{IL} ; V _{CC} = 5.5 V; I _O = 0 A; V _O = V _{CC} or GND; other pins at V _{CC} or GND | - | - | ±0.25 | - | ±2.5 | - | ±10.0 | µA |
| I _I | input leakage current | V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V | - | - | 0.1 | - | 1.0 | - | 2.0 | µA |
| I _{CC} | supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 4.0 | - | 40 | - | 80 | µA |
| ΔI _{CC} | additional supply current | per input pin; V _I = V _{CC} - 2.1 V; I _O = 0 A; other pins at V _{CC} or GND; V _{CC} = 4.5 V to 5.5 V | - | - | 1.35 | - | 1.5 | - | 1.5 | mA |
| C _I | input capacitance | | - | 3 | 10 | - | 10 | - | 10 | pF |
| C _O | output capacitance | | - | 4.0 | - | - | - | - | - | pF |

10. Dynamic characteristics

Table 7. Dynamic characteristics
GND = 0 V. For test circuit see Figure 10.

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit | |
|--------------------------|-------------------|---|-------|--------------------|------|------------------|------|-------------------|------|------|--|
| | | | Min | Typ ^[1] | Max | Min | Max | Min | Max | | |
| For type 74AHC574 | | | | | | | | | | | |
| t _{pd} | propagation delay | CP to Qn; see Figure 7 ^[2] | | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | | | | | | | | | |
| | | C _L = 15 pF | - | 6.5 | 13.2 | 1.0 | 15.5 | 1.0 | 16.5 | ns | |
| | | C _L = 50 pF | - | 9.3 | 16.7 | 1.0 | 19.0 | 1.0 | 21.0 | ns | |
| | | V _{CC} = 4.5 V to 5.5 V | | | | | | | | | |
| | | C _L = 15 pF | - | 4.4 | 8.6 | 1.0 | 10.0 | 1.0 | 11.0 | ns | |
| | | C _L = 50 pF | - | 6.2 | 10.6 | 1.0 | 12.0 | 1.0 | 13.5 | ns | |
| t _{en} | enable time | OE to Qn; see Figure 9 ^[1] | | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | | | | | | | | | |
| | | C _L = 15 pF | - | 5.7 | 12.8 | 1.0 | 15.0 | 1.0 | 16.0 | ns | |
| | | C _L = 50 pF | - | 8.2 | 16.3 | 1.0 | 18.5 | 1.0 | 20.5 | ns | |
| | | V _{CC} = 4.5 V to 5.5 V | | | | | | | | | |
| | | C _L = 15 pF | - | 4.2 | 9.0 | 1.0 | 10.5 | 1.0 | 11.5 | ns | |
| | | C _L = 50 pF | - | 5.9 | 11.0 | 1.0 | 12.5 | 1.0 | 14.0 | ns | |
| t _{dis} | disable time | OE to Qn; see Figure 9 ^[2] | | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | | | | | | | | | |
| | | C _L = 15 pF | - | 6.3 | 13.0 | 1.0 | 15.0 | 1.0 | 16.5 | ns | |
| | | C _L = 50 pF | - | 9.1 | 15.0 | 1.0 | 17.0 | 1.0 | 19.0 | ns | |
| | | V _{CC} = 4.5 V to 5.5 V | | | | | | | | | |
| | | C _L = 15 pF | - | 4.3 | 9.0 | 1.0 | 10.5 | 1.0 | 11.5 | ns | |
| | | C _L = 50 pF | - | 6.9 | 10.1 | 1.0 | 11.5 | 1.0 | 13.0 | ns | |
| f _{max} | maximum frequency | CP; see Figure 7 | | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | | | | | | | | | |
| | | C _L = 15 pF | 80 | 125 | - | 65 | - | 65 | - | MHz | |
| | | C _L = 50 pF | 50 | 75 | - | 45 | - | 45 | - | MHz | |
| | | V _{CC} = 4.5 V to 5.5 V | | | | | | | | | |
| | | C _L = 15 pF | 130 | 180 | - | 110 | - | 110 | - | MHz | |
| | | C _L = 50 pF | 85 | 115 | - | 75 | - | 75 | MHz | | |
| t _w | pulse width | CP; HIGH or LOW; see Figure 7 | | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V; C _L = 50 pF | 5.0 | - | - | 5.0 | - | 5.0 | - | ns | |
| | | V _{CC} = 4.5 V to 5.5 V; C _L = 50 pF | 5.0 | - | - | 5.0 | - | 5.0 | - | ns | |

Table 7. Dynamic characteristics ...continued
GND = 0 V. For test circuit see Figure 10.

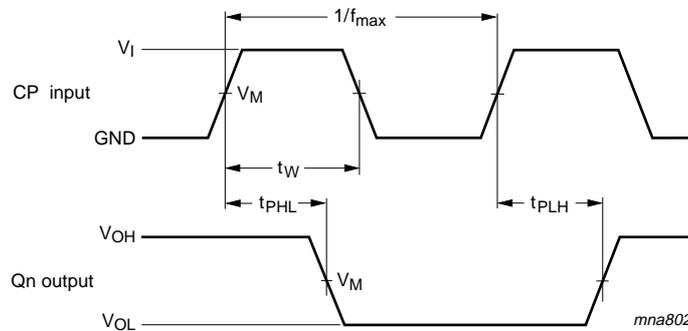
| Symbol | Parameter | Conditions | 25 °C | | | –40 °C to +85 °C | | –40 °C to +125 °C | | Unit |
|---------------------------|-------------------------------|--|----------------|--------------------|------|------------------|------|-------------------|------|------|
| | | | Min | Typ ^[1] | Max | Min | Max | Min | Max | |
| t _{su} | set-up time | Dn to CP; see Figure 8 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V; C _L = 50 pF | 3.5 | - | - | 3.5 | - | 3.5 | - | ns |
| | | V _{CC} = 4.5 V to 5.5 V; C _L = 50 pF | 3.0 | - | - | 3.0 | - | 3.0 | - | ns |
| t _h | hold time | Dn to CP; see Figure 8 | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V; C _L = 50 pF | 1.5 | - | - | 1.5 | - | 1.5 | - | ns |
| | | V _{CC} = 4.5 V to 5.5 V; C _L = 50 pF | 1.5 | - | - | 1.5 | - | 1.5 | - | ns |
| C _{PD} | power dissipation capacitance | C _L = 50 pF; f _i = 1 MHz; V _I = GND to V _{CC} | ^[3] | - | 10 | - | - | - | - | pF |
| For type 74AHCT574 | | | | | | | | | | |
| t _{pd} | propagation delay | CP to Qn; see Figure 7 | | ^[2] | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | | | | | | | | |
| | | C _L = 15 pF | - | 4.4 | 8.6 | 1.0 | 10.0 | 1.0 | 11.0 | ns |
| | | C _L = 50 pF | - | 6.3 | 10.6 | 1.0 | 12.0 | 1.0 | 13.5 | ns |
| t _{en} | enable time | $\overline{\text{OE}}$ to Qn; see Figure 9 | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | | | | | | | | |
| | | C _L = 15 pF | - | 4.3 | 9.0 | 1.0 | 10.5 | 1.0 | 11.5 | ns |
| | | C _L = 50 pF | - | 6.1 | 11.0 | 1.0 | 12.5 | 1.0 | 14.0 | ns |
| t _{dis} | disable time | $\overline{\text{OE}}$ to Qn; see Figure 9 | | ^[2] | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | | | | | | | | |
| | | C _L = 15 pF | - | 4.3 | 9.0 | 1.0 | 10.5 | 1.0 | 11.5 | ns |
| | | C _L = 50 pF | - | 6.2 | 10.1 | 1.0 | 11.5 | 1.0 | 13.0 | ns |
| f _{max} | maximum frequency | CP; see Figure 7 | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | | | | | | | | |
| | | C _L = 15 pF | 130 | 180 | - | 110 | - | 110 | - | MHz |
| | | C _L = 50 pF | 85 | 115 | - | 75 | - | 75 | - | MHz |
| t _w | pulse width | CP; HIGH or LOW; see Figure 7 | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V; C _L = 50 pF | 5.0 | - | - | 5.5 | - | 5.5 | - | ns |
| t _{su} | set-up time | Dn to CP; see Figure 8 | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V; C _L = 50 pF | 3.0 | - | - | 3.5 | - | 3.5 | - | ns |

Table 7. Dynamic characteristics ...continued
 GND = 0 V. For test circuit see [Figure 10](#).

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|----------|-------------------------------|--|-------|--------------------|-----|------------------|-----|-------------------|-----|------|
| | | | Min | Typ ^[1] | Max | Min | Max | Min | Max | |
| t_h | hold time | Dn to CP; see Figure 8 $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V};$ $C_L = 50 \text{ pF}$ | 1.5 | - | - | 1.5 | - | 1.5 | - | ns |
| C_{PD} | power dissipation capacitance | per buffer; $C_L = 50 \text{ pF}; f = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$ | [3] | - | 12 | - | - | - | - | pF |

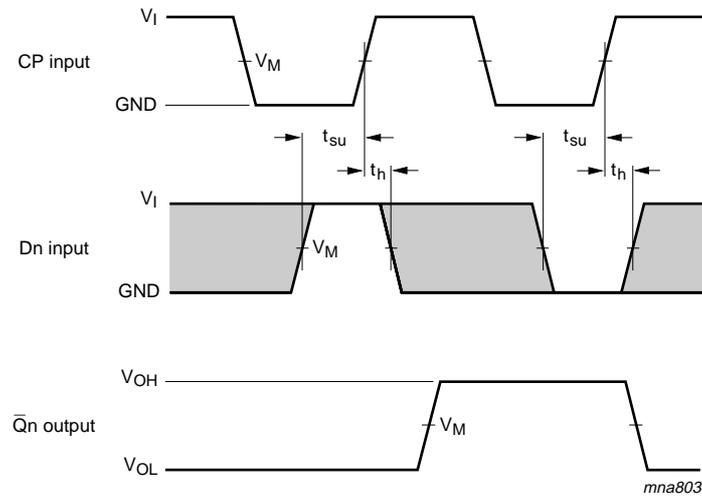
- [1] Typical values are measured at nominal supply voltage ($V_{CC} = 3.3 \text{ V}$ and $V_{CC} = 5.0 \text{ V}$).
- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
 t_{en} is the same as t_{PZL} and t_{PZH} .
 t_{dis} is the same as t_{PLZ} and t_{PHZ} .
- [3] C_{PD} is used to determine the dynamic power dissipation P_D (μW).
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:
 f_i = input frequency in MHz;
 f_o = output frequency in MHz;
 C_L = output load capacitance in pF;
 V_{CC} = supply voltage in V.

10.1 Waveforms



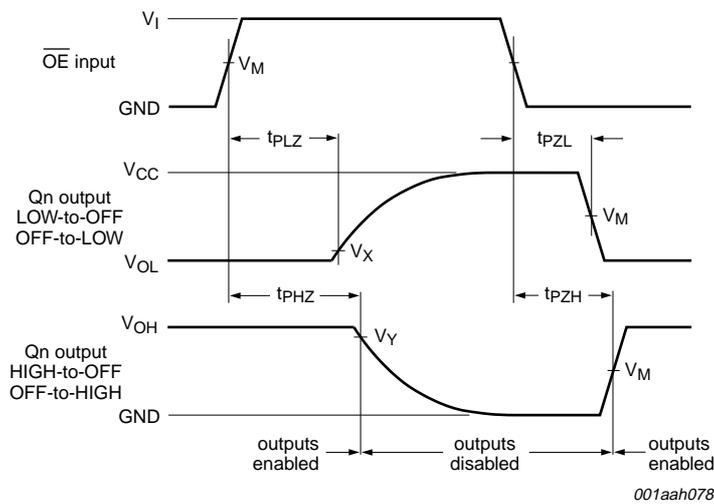
Measurement points are given in [Table 8](#).
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig 7. Propagation delay input (CP) to output (Qn), clock input (CP) pulse width and the maximum frequency (CP)



Measurement points are given in [Table 8](#).
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.
 The shaded areas indicate when the input is permitted to change for predicable output performance.

Fig 8. The data input (D) to clock input (CP) set-up times and clock input (CP) to data input (D) hold times

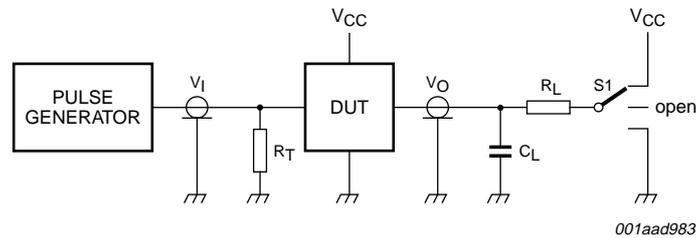
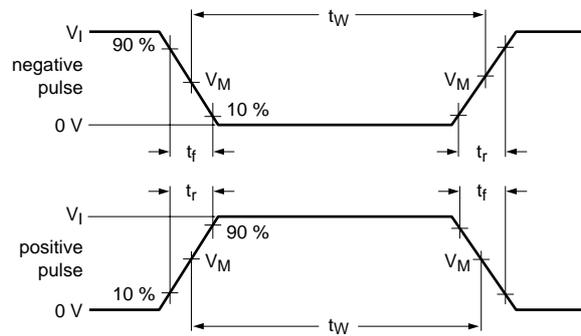


Measurement points are given in [Table 8](#).
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig 9. Enable and disable times

Table 8. Measurement points

| Type | Input | Output | | |
|-----------|-------------|-------------|------------------|------------------|
| | V_M | V_M | V_X | V_Y |
| 74AHC574 | $0.5V_{CC}$ | $0.5V_{CC}$ | $V_{OL} + 0.3 V$ | $V_{OH} - 0.3 V$ |
| 74AHCT574 | 1.5 V | $0.5V_{CC}$ | $V_{OL} + 0.3 V$ | $V_{OH} - 0.3 V$ |



001aad983

Test data is given in [Table 9](#).

Definitions test circuit:

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

C_L = Load capacitance including jig and probe capacitance.

R_L = Load resistance.

S1 = Test selection switch.

Fig 10. Load circuitry for switching times

Table 9. Test data

| Type | Input | | Load | | S1 position | | |
|-----------|----------|------------|--------------|--------------|--------------------|--------------------|--------------------|
| | V_I | t_r, t_f | C_L | R_L | t_{PHL}, t_{PLH} | t_{PZH}, t_{PHZ} | t_{PZL}, t_{PLZ} |
| 74AHC574 | V_{CC} | 3.0 ns | 15 pF, 50 pF | 1 k Ω | open | GND | V_{CC} |
| 74AHCT574 | 3.0 V | 3.0 ns | 15 pF, 50 pF | 1 k Ω | open | GND | V_{CC} |

11. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1

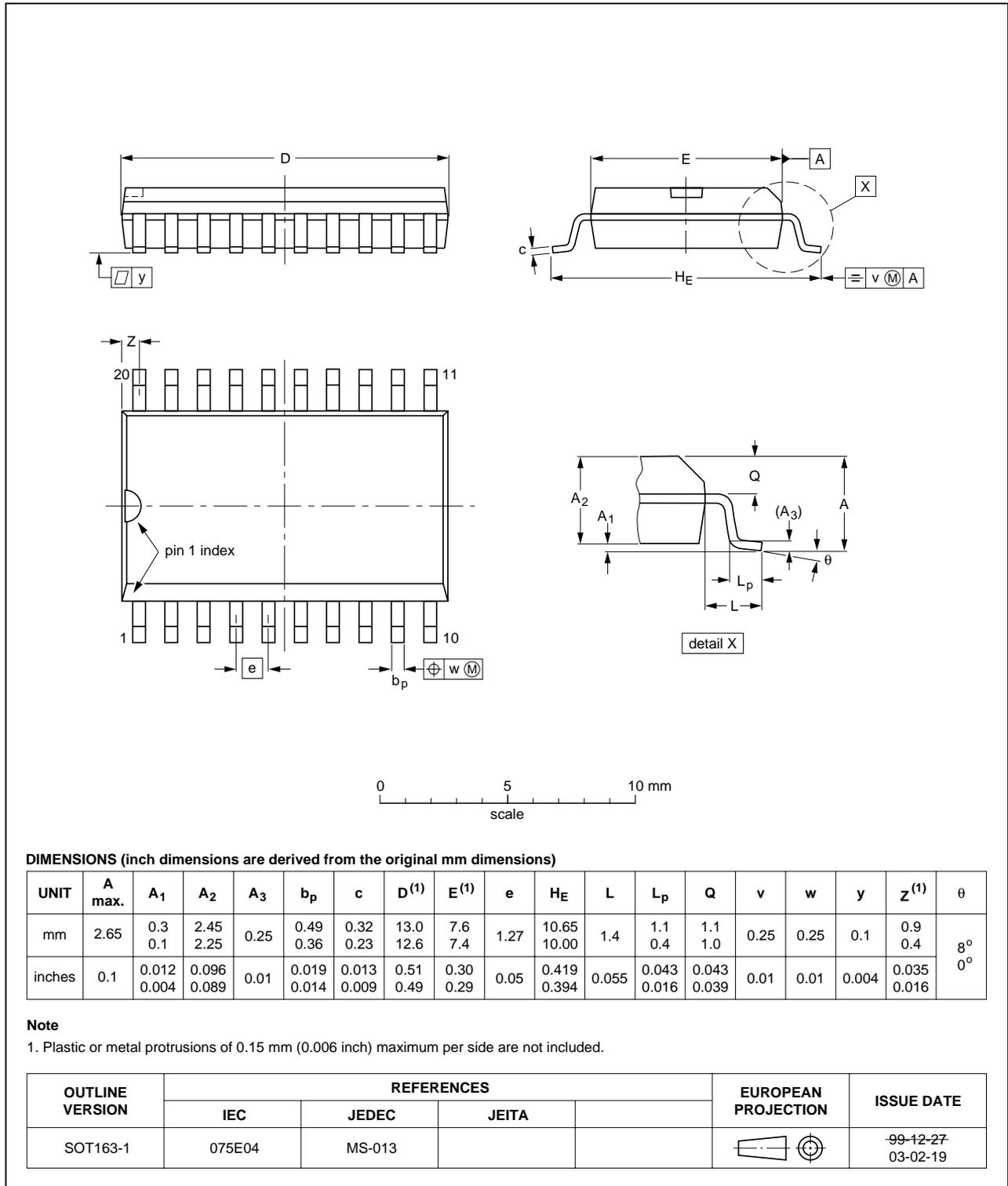


Fig 11. Package outline SOT163-1 (SO20)

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

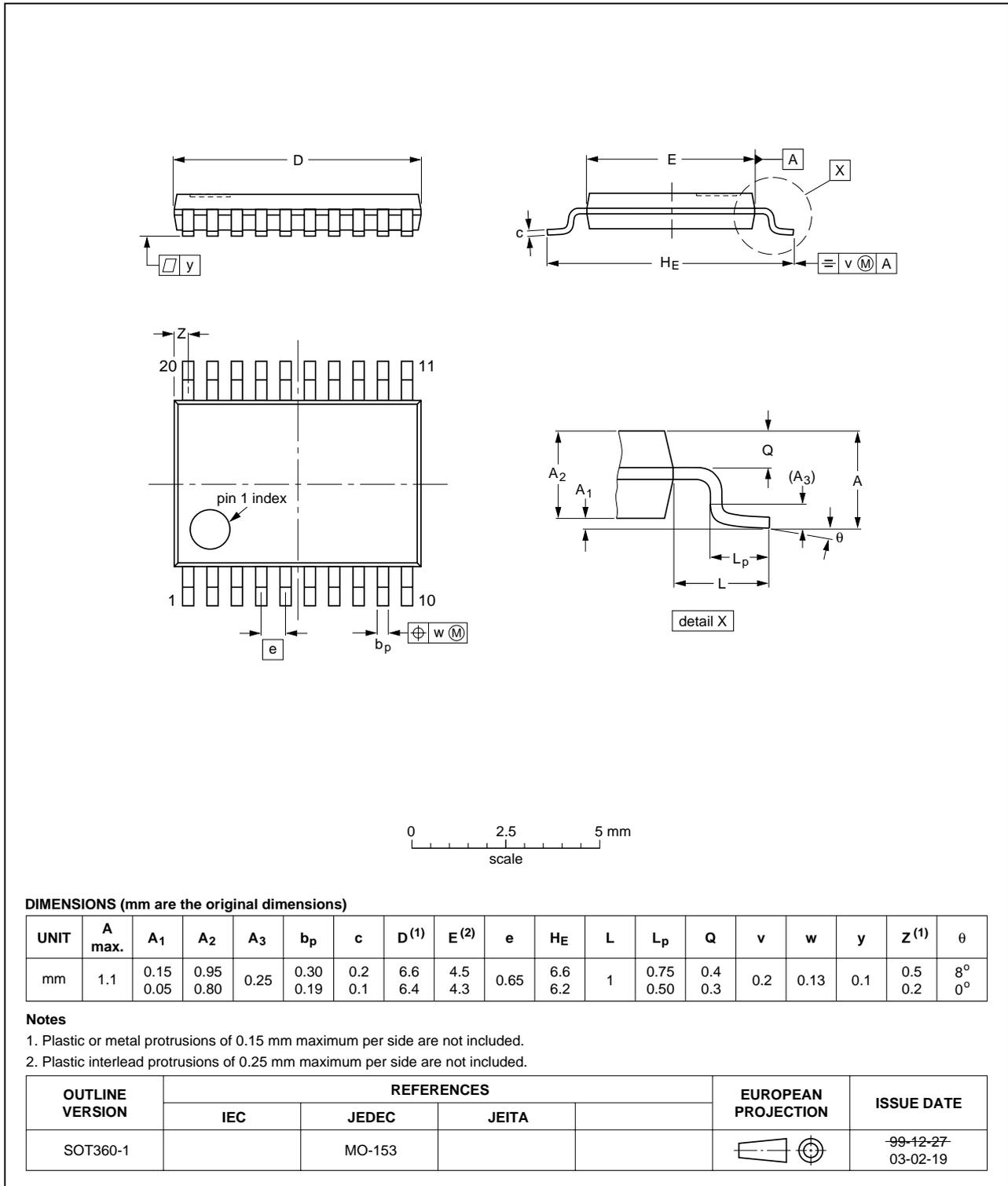


Fig 12. Package outline SOT360-1 (TSSOP20)

DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm

SOT764-1

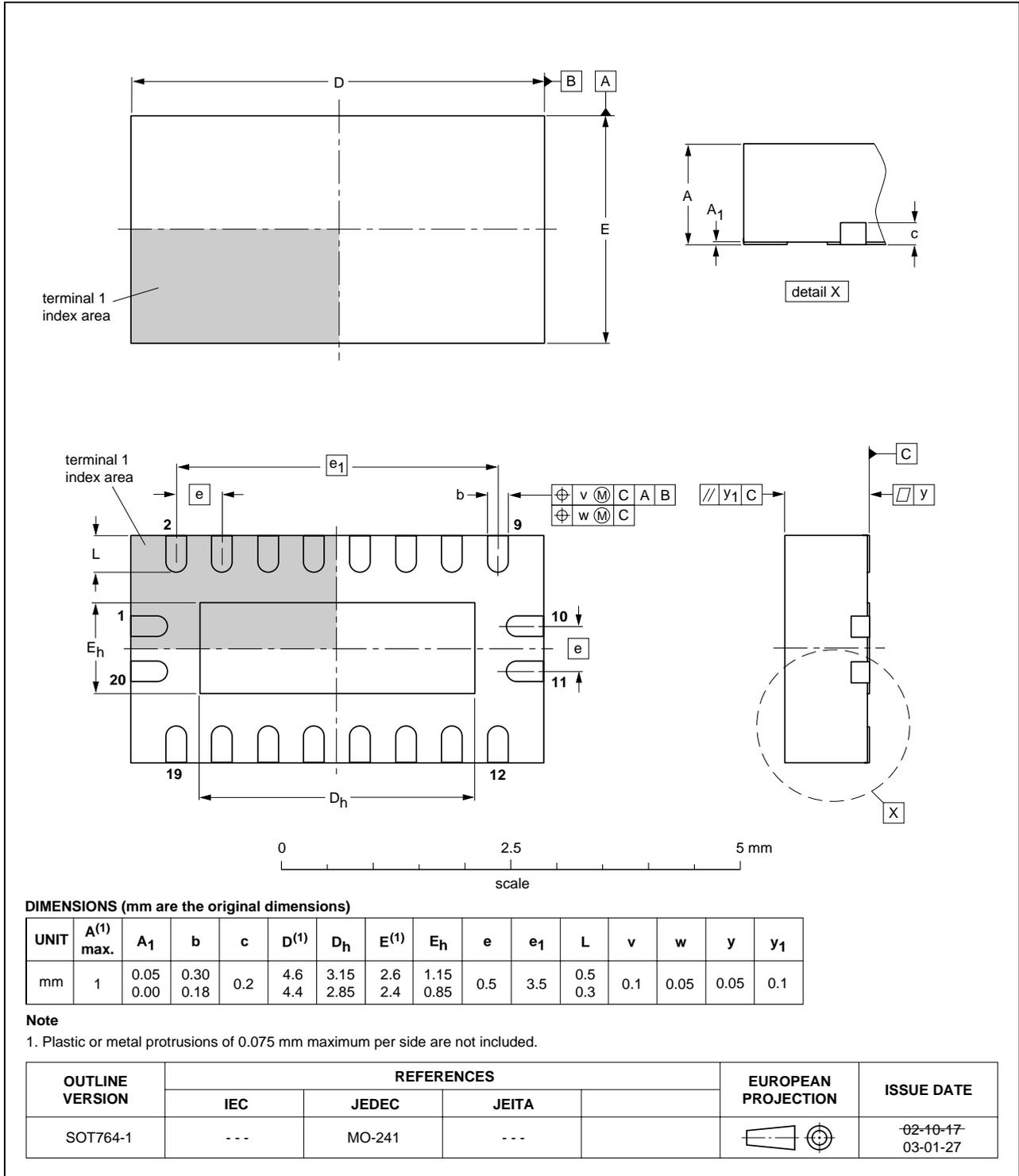


Fig 13. Package outline SOT764-1 (DHVQFN20)

12. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|---|
| CDM | Charged-Device Model |
| CMOS | Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

13. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|-----------------|--|-----------------------|---------------|-----------------|
| 74AHC_AHCT574_2 | 20080124 | Product data sheet | - | 74AHC_AHCT574_1 |
| Modifications: | <ul style="list-style-type: none"> The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. Section 3: DHVQFN20 package added. Section 7: derating values added for DHVQFN20 package. Section 11: outline drawing added for DHVQFN20 package. | | | |
| 74AHC_AHCT574_1 | 19990616 | Product specification | - | - |

14. Legal information

14.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

14.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

14.3 Disclaimers

General — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or

malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nxp.com/profile/terms>, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

14.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

15. Contact information

For more information, please visit: <http://www.nxp.com>

For sales office addresses, please send an email to: salesaddresses@nxp.com

16. Contents

| | | |
|-----------|---|-----------|
| 1 | General description | 1 |
| 2 | Features | 1 |
| 3 | Ordering information | 2 |
| 4 | Functional diagram | 2 |
| 5 | Pinning information | 4 |
| 5.1 | Pinning | 4 |
| 5.2 | Pin description | 4 |
| 6 | Functional description | 5 |
| 7 | Limiting values | 5 |
| 8 | Recommended operating conditions | 6 |
| 9 | Static characteristics | 6 |
| 10 | Dynamic characteristics | 8 |
| 10.1 | Waveforms | 10 |
| 11 | Package outline | 13 |
| 12 | Abbreviations | 16 |
| 13 | Revision history | 16 |
| 14 | Legal information | 17 |
| 14.1 | Data sheet status | 17 |
| 14.2 | Definitions | 17 |
| 14.3 | Disclaimers | 17 |
| 14.4 | Trademarks | 17 |
| 15 | Contact information | 17 |
| 16 | Contents | 18 |

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

founded by

PHILIPS

© NXP B.V. 2008.

All rights reserved.

For more information, please visit: <http://www.nxp.com>

For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 24 January 2008

Document identifier: 74AHC_AHCT574_2

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[NXP:](#)

[74AHC574BQ,115](#) [74AHC574D,112](#) [74AHC574D,118](#) [74AHC574PW,112](#) [74AHC574PW,118](#) [74AHCT574BQ,115](#)
[74AHCT574D,112](#) [74AHCT574D,118](#) [74AHCT574PW,112](#) [74AHCT574PW,118](#)